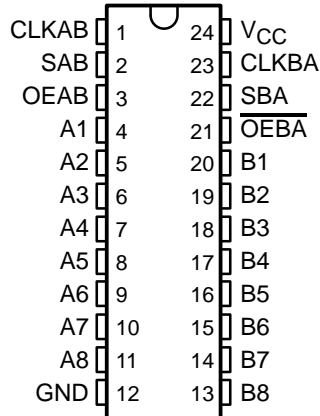


SN54HCT652, SN74HCT652 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

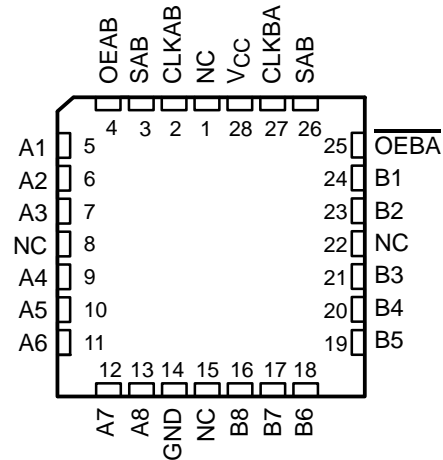
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- Operating Voltage Range of 4.5 V to 5.5 V
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 12$ ns
- ± 6 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Inputs Are TTL-Voltage Compatible
- Independent Registers and Enables for A and B Buses
- Multiplexed Real-Time and Stored Data
- True Data Paths
- High-Current 3-State Outputs Can Drive Up To 15 LSTTL Loads

SN54HCT652 . . . JT OR W PACKAGE
SN74HCT652 . . . DW OR NT PACKAGE
(TOP VIEW)



SN54HCT652 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The 'HCT652 devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Output-enable (OEAB and \overline{OEBA}) inputs are provided to control the transceiver functions. Select-control (SAB and SBA) inputs are provided to select real-time or stored data transfer. A low input level selects real-time data; a high input level selects stored data. Figure 1 illustrates the four fundamental bus-management functions that can be performed with these devices.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – NT	Tube	SN74HCT652NT	HCT652
	SOIC – DW	Tube	SN74HCT652DW	
		Tape and reel	SN74HCT652DWR	
-55°C to 125°C	CDIP – JT	Tube	SNJ54HCT652JT	SNJ54HCT652JT
	CFP – W	Tube	SNJ54HCT652W	SNJ54HCT652W
	LCCC – FK	Tube	SNJ54HCT652FK	SNJ54HCT652FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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 **TEXAS
INSTRUMENTS**

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description/ordering information (continued)

Data on the A or B data bus, or both, can be stored in the internal D-type flip-flops by low-to-high transitions at the appropriate clock (CLKAB or CLKBA) terminals, regardless of the select- or output-control terminals. When SAB and SBA are in the real-time transfer mode, it is possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and \overline{OEBA} . In this configuration, each output reinforces its input. When all other data sources to the two sets of bus lines are at high impedance, each set of bus lines remains at its last state.

To ensure the high-impedance state during power up or power down, \overline{OEBA} should be tied to V_{CC} through a pullup resistor and OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

FUNCTION TABLE

INPUTS						DATA I/O†		OPERATION OR FUNCTION
OEAB	\overline{OEBA}	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
L	H	H or L	H or L	X	X	Input	Input	Isolation
L	H	↑	↑	X	X	Input	Input	Store A and B data
X	H	↑	H or L	X	X	Input	Unspecified‡	Store A, hold B
H	H	↑	↑	X‡	X	Input	Output	Store A in both registers
L	X	H or L	↑	X	X	Unspecified‡	Input	Hold A, store B
L	L	↑	↑	X	X‡	Output	Input	Store B in both registers
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
H	H	X	X	L	X	Input	Output	Real-time A data to B bus
H	H	H or L	X	H	X	Input	Output	Stored A data to B bus
H	L	H or L	H or L	H	H	Output	Output	Stored A data to B bus and stored B data to A bus

† The data-output functions can be enabled or disabled by a variety of level combinations at OEAB or \overline{OEBA} . Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition on the clock inputs.

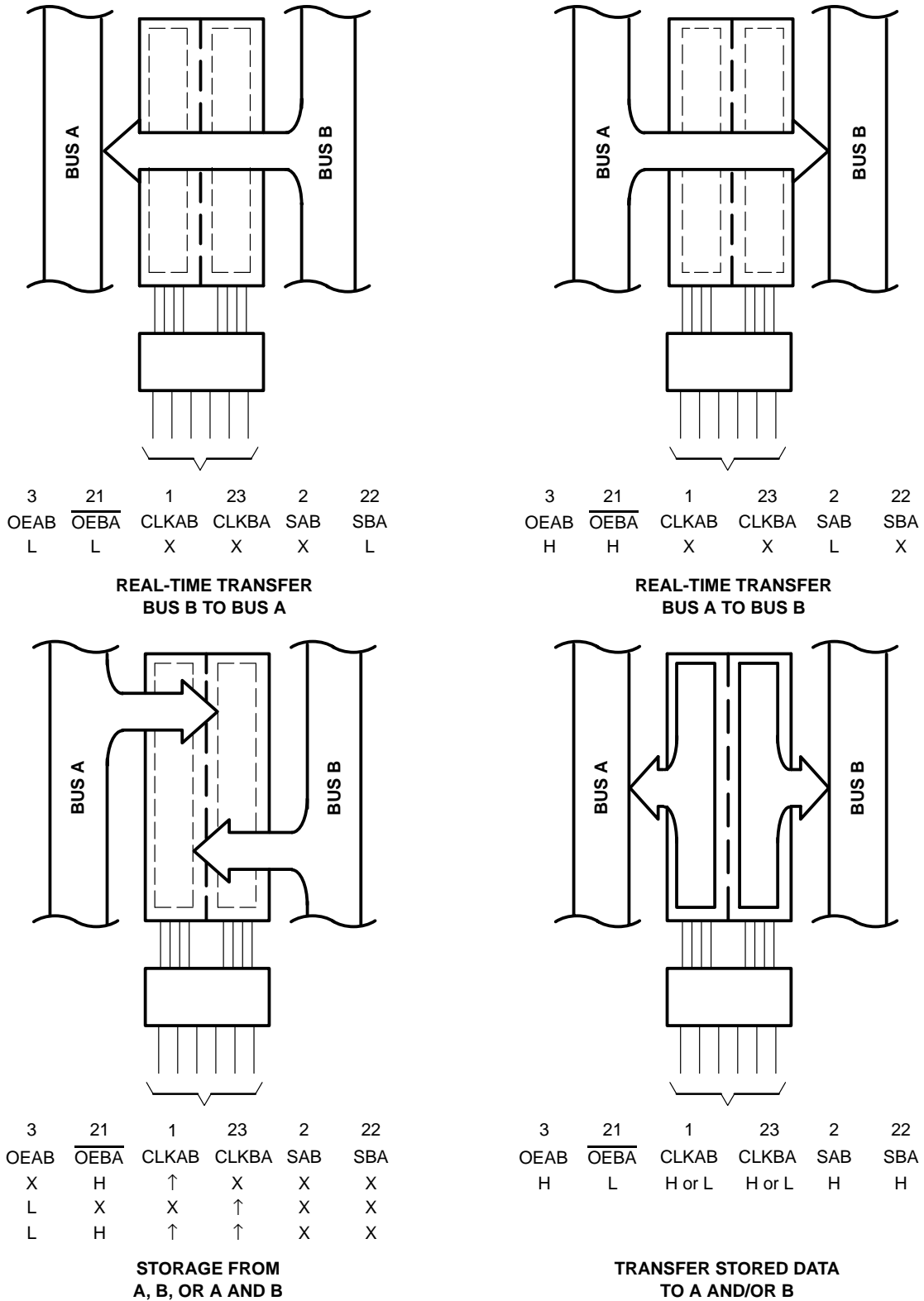
‡ Select control = L: clocks can occur simultaneously.

Select control = H: clocks must be staggered to load both registers.



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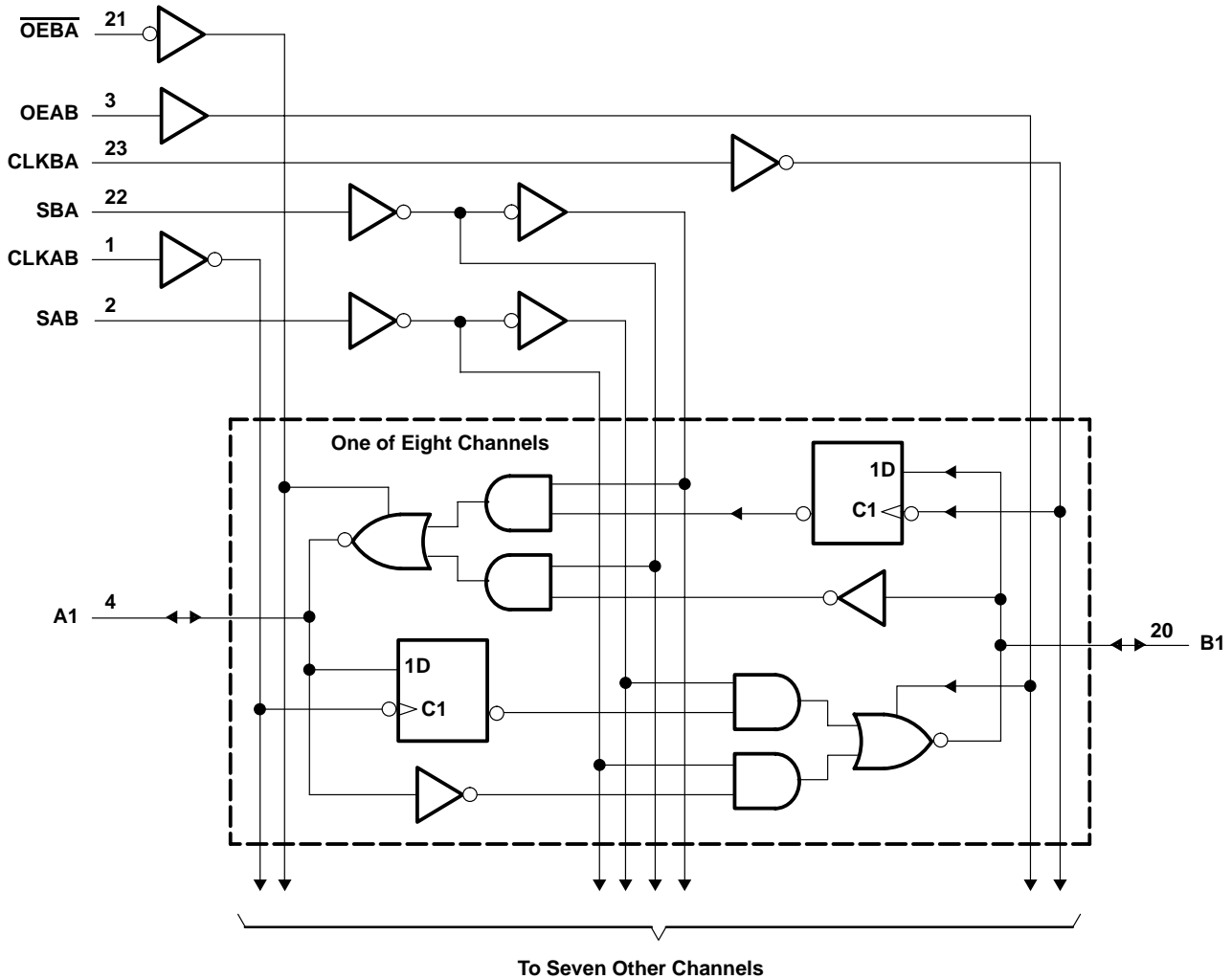
Pin numbers shown are for the DW, JT, NT, and W packages.

Figure 1. Bus-Management Functions

SN54HCT652, SN74HCT652 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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logic diagram (positive logic)



Pin numbers shown are for the DW, JT, NT, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	± 20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 35 mA
Continuous current through V_{CC} or GND	± 70 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package	46°C/W
(see Note 3): NT package	67°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51-7.
 3. The package thermal impedance is calculated in accordance with JESD 51-3.



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recommended operating conditions (see Note 4)

		SN54HCT652			SN74HCT652			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 4.5 V to 5.5 V			2			V
V _{IL}	Low-level input voltage	V _{CC} = 4.5 V to 5.5 V			0.8			V
V _I	Input voltage	0			V _{CC}			V
V _O	Output voltage	0			V _{CC}			V
t _t	Input transition (rise and fall) time	500			500			ns
T _A	Operating free-air temperature	-55			125			°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C		SN54HCT652		SN74HCT652		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	
V _{OH}	V _I = V _{IH} or V _{IL}	4.5 V	I _{OH} = -20 μA		4.4		4.4		V
			I _{OH} = -6 mA		3.98		3.7		
V _{OL}	V _I = V _{IH} or V _{IL}	4.5 V	I _{OL} = 20 μA		0.001		0.1		V
			I _{OL} = 6 mA		0.17		0.26		
I _I	Control inputs	V _I = V _{CC} or 0	5.5 V		±0.1	±100	±1000	±1000	nA
I _{OZ}	A or B	V _O = V _{CC} or 0, V _I = V _{IH} or V _{IL} , Data = V _{CC} or 0	5.5 V		±0.01	±0.5	±10	±5	μA
I _{CC}		V _I = V _{CC} or 0, I _O = 0	5.5 V		8		160		μA
ΔI _{CC} †		One input at 0.5 V or 2.4 V, Other inputs at 0 or V _{CC}	5.5 V		1.4		2.4		mA
C _i	Control inputs	4.5 V to 5.5 V	5.5 V		3		10		pF

† This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V _{CC}	T _A = 25°C		SN54HCT652		SN74HCT652		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	4.5 V	25		17		20		MHz
		5.5 V	28		19		22		
t _w	Pulse duration, CLKBA or CLKAB high or low	4.5 V	20		30		25		ns
		5.5 V	18		27		23		
t _{su}	Setup time, A before CLKAB↑ or B before CLKBA↑	4.5 V	15		23		19		ns
		5.5 V	14		21		17		
t _h	Hold time, A after CLKAB↑ or B after CLKBA↑	4.5 V	5		5		5		ns
		5.5 V	5		5		5		

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switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	T _A = 25°C			SN54HCT652		SN74HCT652		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}			4.5 V	25	35		17		20	MHz	
			5.5 V	28	40		19		22		
t _{pd}	CLKBA or CLKAB	A or B	4.5 V		18	36		54		45	ns
			5.5 V		16	32		49		41	
	A or B	B or A	4.5 V		14	27		41		34	
			5.5 V		12	24		37		31	
	SBA or SAB†	A or B	4.5 V		20	38		57		48	
			5.5 V		17	34		51		43	
t _{en}	$\overline{\text{OEBA}}$ or OEAB	A or B	4.5 V		25	49		74		61	ns
			5.5 V		22	44		67		55	
t _{dis}	$\overline{\text{OEBA}}$ or OEAB	A or B	4.5 V		25	49		74		61	ns
			5.5 V		22	44		67		55	
t _t		Any	4.5 V		9	12		18		15	ns
			5.5 V		7	11		16		14	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	T _A = 25°C			SN54HCT652		SN74HCT652		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{pd}	CLKBA or CLKAB	A or B	4.5 V		24	53		80		66	ns
			5.5 V		22	47		72		60	
	A or B	B or A	4.5 V		22	44		70		55	
			5.5 V		20	39		60		50	
	SBA or SAB†	A or B	4.5 V		26	55		83		69	
			5.5 V		24	49		74		62	
t _{en}	$\overline{\text{OEBA}}$ or OEAB	A or B	4.5 V		33	66		100		82	ns
			5.5 V		30	59		90		74	
t _t		Any	4.5 V		17	42		63		53	ns
			5.5 V		14	38		57		48	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

operating characteristics, T_A = 25°C

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	No load	50	pF

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PARAMETER MEASUREMENT INFORMATION

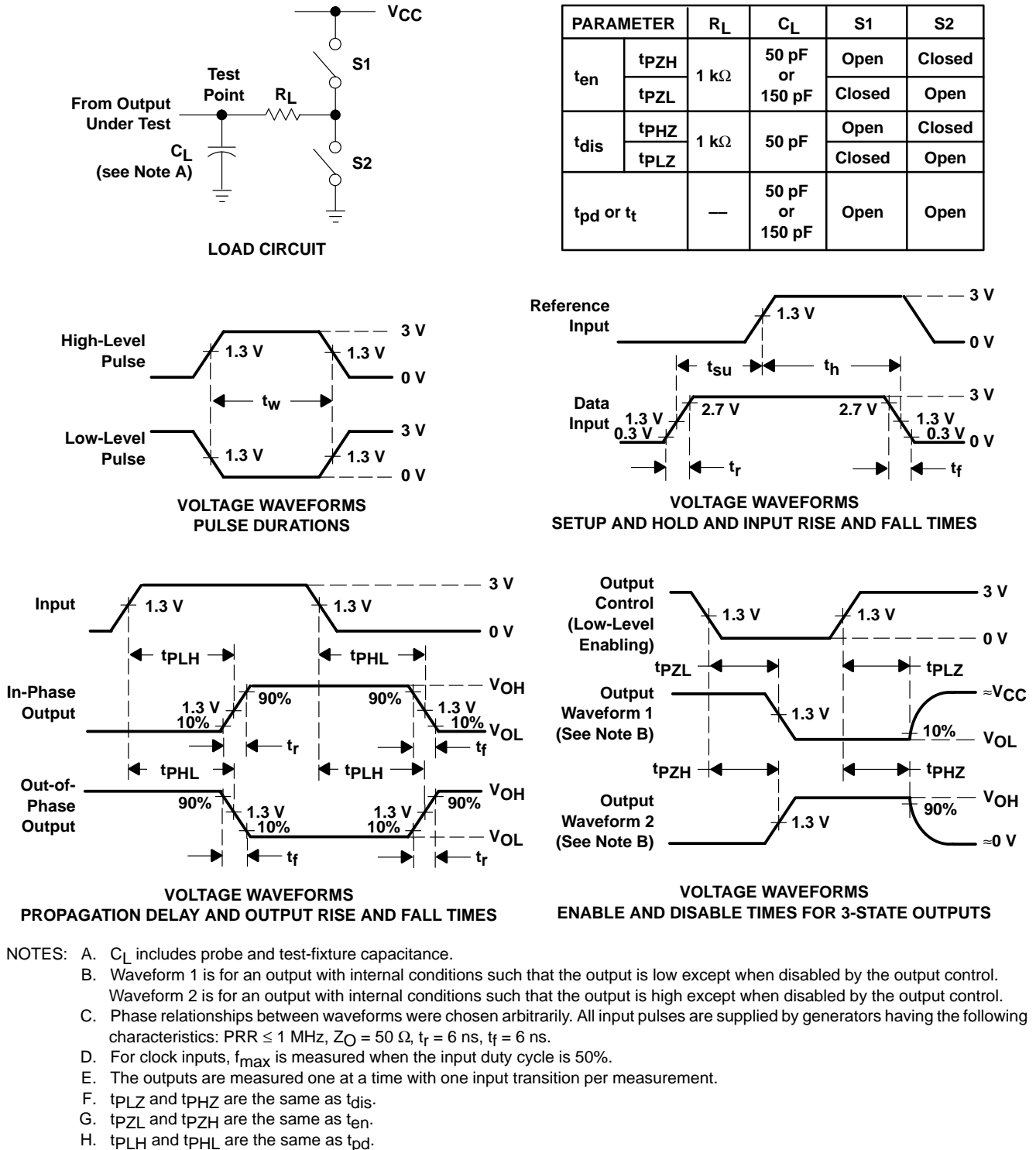


Figure 1. Load Circuit and Voltage Waveforms

NT (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN

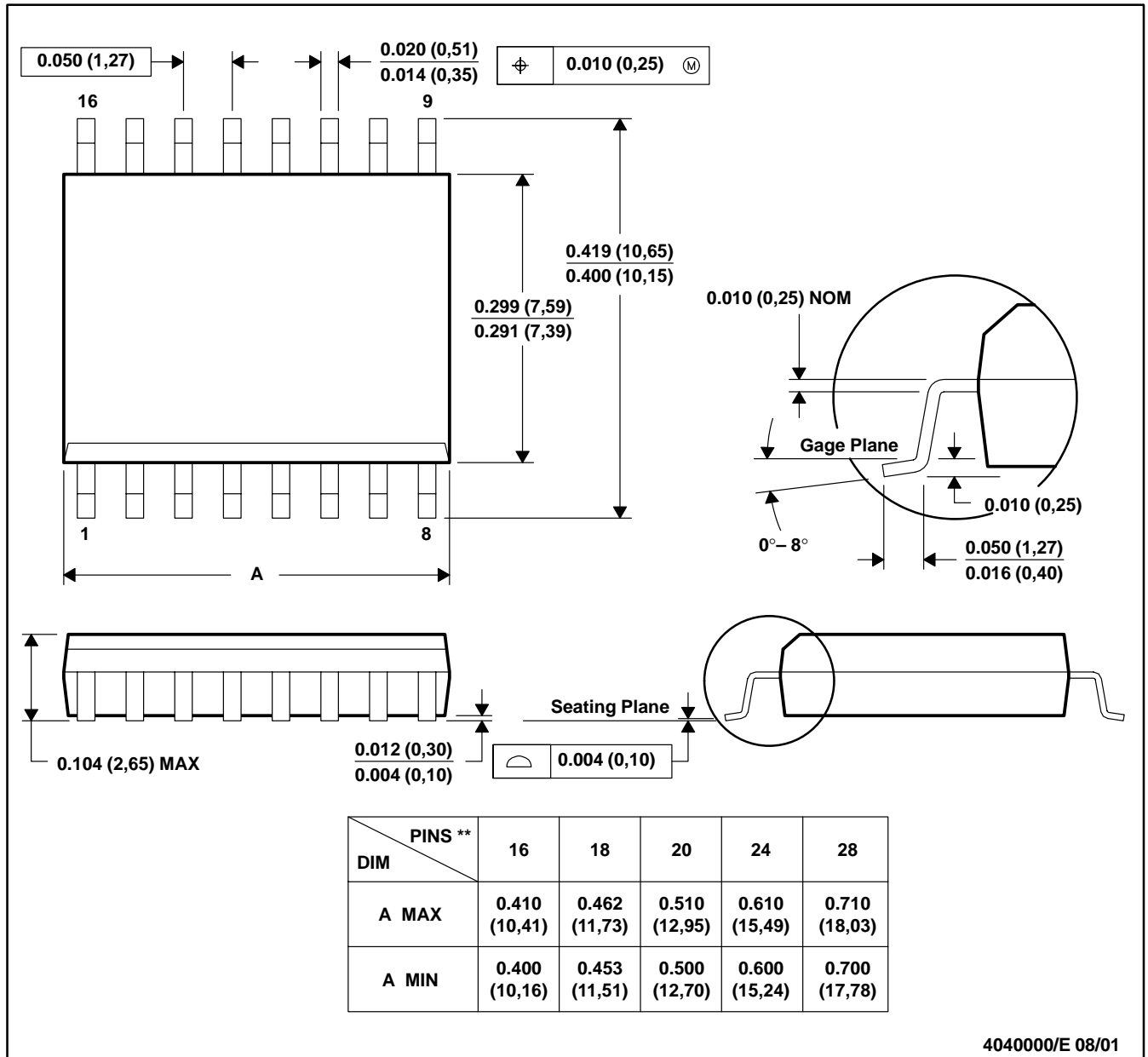


NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



4040000/E 08/01

- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-013

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265